#### PATENT ASSIGNMENT

### Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	CHANGE OF NAME

#### **CONVEYING PARTY DATA**

Name	Execution Date
Li-Peng Wang	02/28/2007

#### **RECEIVING PARTY DATA**

Name:	Intel Corporation	
Street Address:	2200 Mission College Boulevard	
City:	Santa Clara	
State/Country:	CALIFORNIA	
Postal Code:	95052	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11644804

#### CORRESPONDENCE DATA

Fax Number: (612)677-3572

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Email: jgklein@cpaglobal.com

Correspondent Name: Kathy J. Ortiz

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Address Line 4: Santa Clara, CALIFORNIA 95052

ATTORNEY DOCKET NUMBER: P25156

NAME OF SUBMITTER: Kathy J. Ortiz

**Total Attachments: 1** 

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PATENT REEL: 022940 FRAME: 0610

Attorney Docket No.: 42P25156

# **ASSIGNMENT**

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Li-Peng Wang

hereby self, assign, and transfer to:

## Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent entitled:

# METHODS OF FORMING FERROELECTRIC CRYSTALS AS STORAGE MEDIA AND STRUCTURES FORMED THEREBY

(I hereby authorize and request my attorney, associated with Customer Number 59796, to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on December	22, 2006		is
United States Application 1	lumber	11/644,804	and
which has been executed by the undersigned prior h	ereto or concurrently	herewith on the c	late(s) indicated
below, and in and to said application and all design substitute, renewal, reissue, and all other patent app States and all foreign countries on any of said inven reissued patents that have been or shall be issued in inventions and improvements; and in and to all righ States applications;	lications that have bee tions and improvemer the United States and	en or shall be file its: and in and to all foreign count	d in the United all original and tries on said

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Li-Peng Wang (Today's Date)

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RECORDED: 07/10/2009

PATENT REEL: 022940 FRAME: 0611